

Application Data Sheet

Application Information

Application Type::	Regular
Subject Matter::	Utility
Suggested Group Art Unit::	2824
CD-ROM or CD-R?::	None
Sequence submission?::	Paper
Computer Readable Form (CRF)?::	No
Title::	SEMICONDUCTOR CHIP PACKAGE WITH INTERCONNECT STRUCTURE
Attorney Docket Number::	TESSERA 3.0-196 DIV
Request for Early Publication?::	No
Request for Non-Publication?::	No
Suggested Drawing Figure::	Fig. 1
Total Drawing Sheets::	3
Small Entity?::	No
Petition included?::	No
Secrecy Order in Parent Appl.?::	No

Applicant Information

Applicant Authority Type::	Inventor
Primary Citizenship Country::	US
Status::	Full Capacity
Given Name::	John
Middle Name::	W.
Family Name::	Smith
City of Residence::	Horseshoe Bay
State or Province of Residence::	TX
Country of Residence::	US
Street of mailing address::	2826 Aurora Horseshoe
City of mailing address::	Horseshoe Bay

State or Province of mailing address:: TX
Postal or Zip Code of mailing address:: 78657

Applicant Authority Type:: Inventor
Primary Citizenship Country:: Algeria
Status:: Full Capacity
Given Name:: Belgacem
Family Name:: Haba
City of Residence:: Cupertino
State or Province of Residence:: CA
Country of Residence:: US
Street of mailing address:: 10541 Cypress Court
City of mailing address:: Cupertino
State or Province of mailing address:: CA
Postal or Zip Code of mailing address:: 95014

Correspondence Information

Correspondence Customer Number:: 038091

Representative Information

Representative Customer Number:: 038091

Domestic Priority Information

Application::	Continuity Type::	Parent Application::	Parent Filing Date::
This Application	Division of	09/850,973	05/08/01
09/850,973	An application claiming the benefit under 35 USC 119(e)	60/203,190	05/08/00

Assignee Information

Assignee name:: Tessera, Inc.
Street of mailing address:: 3099 Orchard Drive

City of mailing address:: San Jose
State or Province of mailing address:: CA
Postal or Zip Code of mailing address:: 95134